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Kind regards,

Team Nexperia



PHD38N02LT N-channel TrenchMOS logic level FET Rev. 02 – 2 February 2007

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology.

1.2 Features

Low on-state resistance



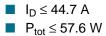
1.3 Applications

Linear regulator for Double-Data Rate (DDR) memory

1.4 Quick reference data

$\bullet V_{DS} \le 20 \text{ V}$

R_{DSon} \leq 16 m Ω



2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	gate (G)	_	2
2	drain (D)	[<u>1]</u> mb	
3	source (S)		
mb	mounting base; connected to drain (D)		mbb076 S
		SOT428 (DPAK)	

[1] It is not possible to make a connection to pin 2.



3. Ordering information

Table 2. Ordering information					
Type number	Package				
	Name	Description	Version		
PHD38N02LT	DPAK	plastic single-ended surface-mounted package; 3 leads (one lead cropped)	SOT428		

4. Limiting values

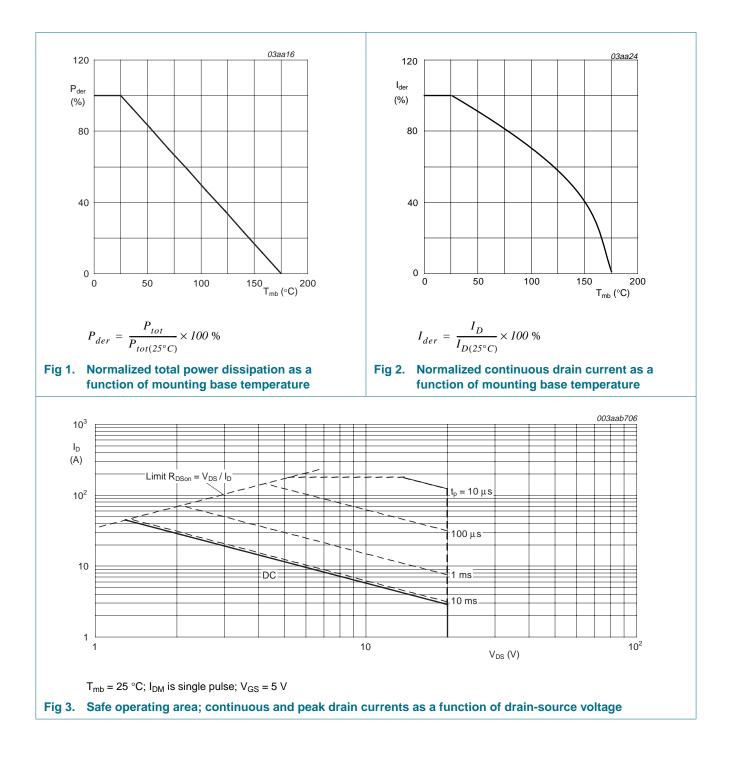
Table 3.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	$25 \text{ °C} \leq T_j \leq 175 \text{ °C}$	-	20	V
V _{DGR}	drain-gate voltage (DC)	25 °C \leq T $_{j}$ \leq 175 °C; R $_{GS}$ = 20 k Ω	-	20	V
V _{GS}	gate-source voltage		-	±12	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 5 V; see <u>Figure 2</u> and <u>3</u>	-	44.7	А
		T_{mb} = 100 °C; V_{GS} = 5 V; see <u>Figure 2</u>	-	31.6	А
I _{DM}	peak drain current	T_{mb} = 25 °C; pulsed; $t_p \leq$ 10 $\mu s;$ see $\underline{Figure~3}$	-	179	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 1</u>	-	57.6	W
T _{stg}	storage temperature		-55	+175	°C
Tj	junction temperature		-55	+175	°C
Source-o	drain diode				
I _S	source current	T _{mb} = 25 °C	-	44.7	А
I _{SM}	peak source current	T_{mb} = 25 °C; pulsed; $t_p \leq$ 10 μs	-	179	А

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PHD38N02LT

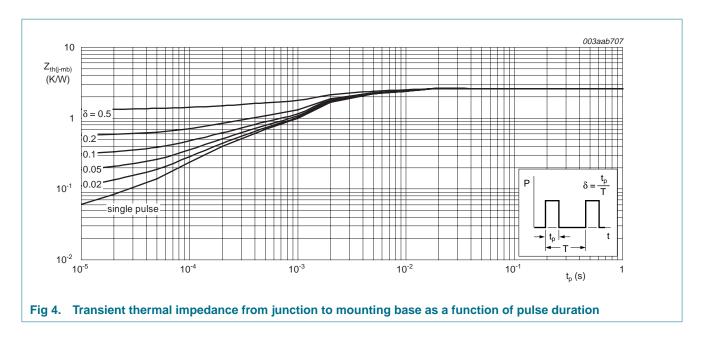


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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 4	-	-	2.6	K/W
R _{th(j-a)}	thermal resistance from junction to ambient					
	SOT428	minimum footprint	-	75	-	K/W
		SOT404 minimum footprint	<u>[1]</u> _	50	-	K/W

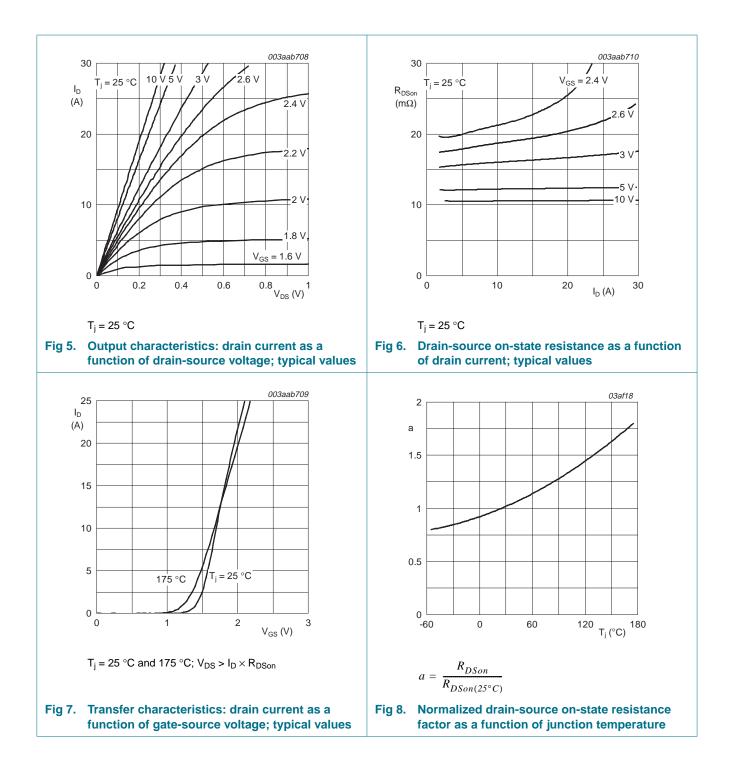
[1] Mounted on a printed-circuit board; vertical in still air.



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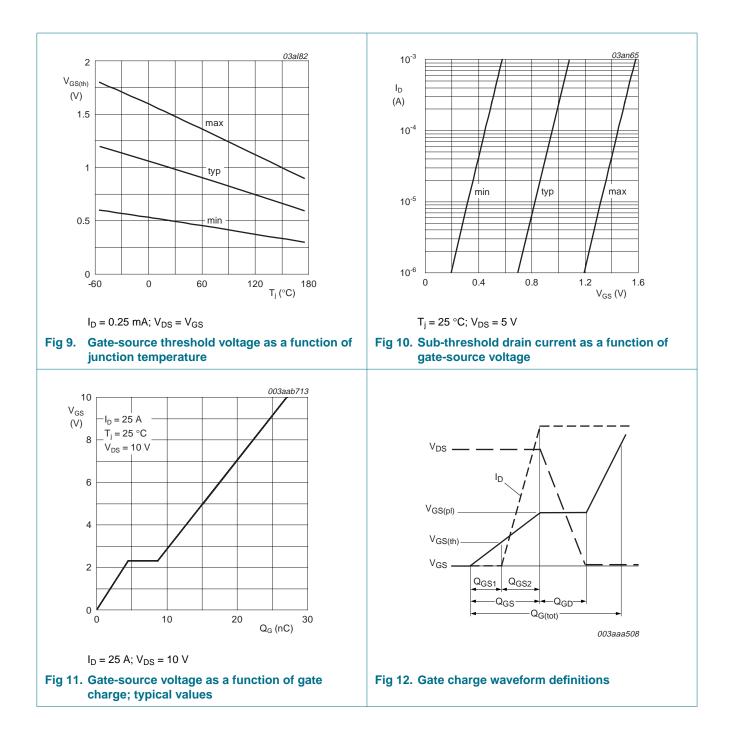
6. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \ \mu A; \ V_{GS} = 0 \ V$				
		T _j = 25 °C	20	-	-	V
		$T_j = -55 \ ^{\circ}C$	18	-	-	V
V _{GS(th)}	gate-source threshold voltage	I_D = 250 μ A; V_{DS} = V_{GS} ; see Figure 9 and 10				
		T _j = 25 °C	0.5	1.0	1.5	V
		T _j = 175 °C	0.3	-	-	V
		$T_j = -55 \ ^{\circ}C$	-	-	1.8	V
I _{DSS}	drain leakage current	$V_{DS} = 20 \text{ V}; V_{GS} = 0 \text{ V}$				
		T _j = 25 °C	-	0.05	1.0	μΑ
		T _j = 175 °C	-	-	500	μΑ
I _{GSS}	gate leakage current	$V_{GS} = \pm 12 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
DOON	drain-source on-state resistance	$V_{GS} = 5 \text{ V}; \text{ I}_{D} = 25 \text{ A}; \text{ see } \frac{\text{Figure 6}}{\text{Figure 6}} \text{ and } \frac{8}{2}$				
		$T_j = 25 \ ^{\circ}C$	-	13.5	16	mΩ
		T _j = 175 °C	-	24.3	28.8	mΩ
Dynamic	characteristics					
Q _{G(tot)}	total gate charge	$I_D = 25 \text{ A}; V_{DS} = 10 \text{ V}; V_{GS} = 5 \text{ V};$	-	15.1	-	nC
Q _{GS}	gate-source charge	see Figure 11 and 12	-	4.5	-	nC
Q _{GD}	gate-drain charge		-	4.2	-	nC
C _{iss}	input capacitance	$V_{GS} = 0 V; V_{DS} = 20 V; f = 1 MHz;$	-	800	-	pF
C _{oss}	output capacitance	see Figure 14	-	260	-	pF
C _{rss}	reverse transfer capacitance		-	190	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 10 V; I_{D} = 25 A; V_{GS} = 10 V;	-	4	-	ns
t _r	rise time	$R_{G} = 5.6 \Omega$	-	12.5	-	ns
t _{d(off)}	turn-off delay time		-	30	-	ns
t _f	fall time		-	23	-	ns
Source-	drain diode					
V _{SD}	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; \text{ see } \frac{\text{Figure } 13}{100000000000000000000000000000000000$	-	0.98	1.2	V



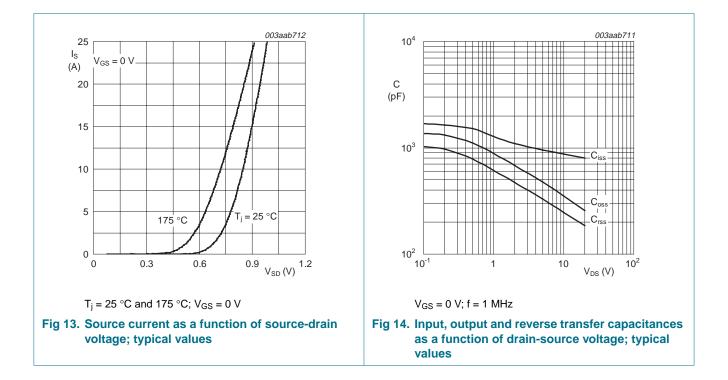
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7. Package outline

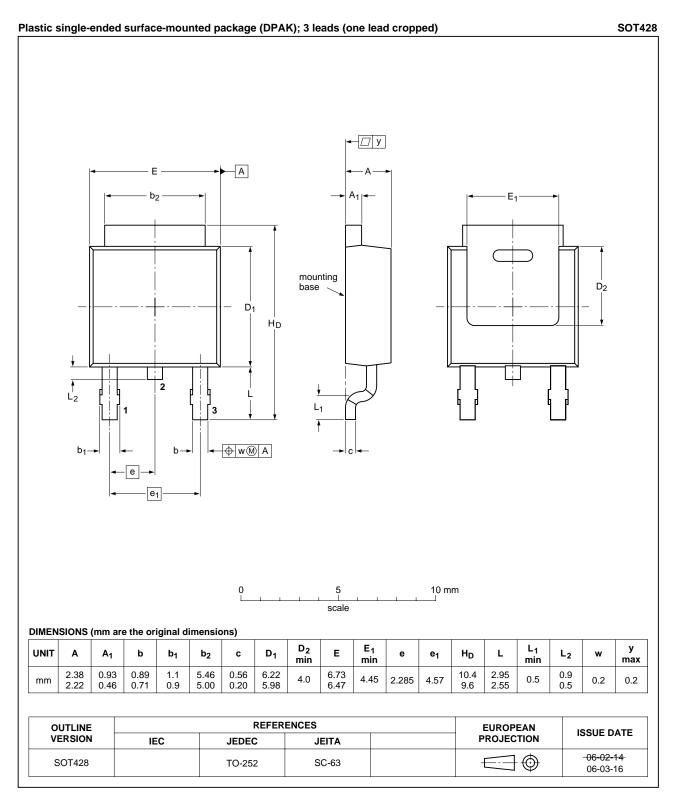


Fig 15. Package outline SOT428 (DPAK)

PHD38N02LT_2
Product data sheet

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8. Revision history

Table 6. Revision hi	story					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
PHD38N02LT_2	20070202	Product data sheet	-	PHB_PHD38N02LT-01		
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts have been adapted to the new company name where appropriate. 					
	 PHB38N02LT has been discontinued. 					
PHB_PHD38N02LT-01 (9397 750 11614)	20030630	Product data	-	-		

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9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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